

v01.0700

HMC221

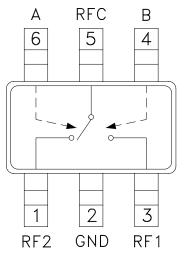
GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

Typical Applications

The HMC221 is ideal for:

- ISM Applications
- PCMCIA Wireless Cards
- Cellular Applications

Functional Diagram



Features

Low Insertion Loss: 0.4 dB Ultra Small Package: SOT26 Input IP3: +45 dBm Positive Control: 0/+3V @ 10 uA

General Description

The HMC221 is a low-cost SPDT switch in a 6-lead SOT26 plastic package for use in general switching applications which require very low insertion loss and very small size. The device can control signals from DC to 3.0 GHz and is especially suited for 900 MHz, 1.8 - 2.2 GHz, and 2.4 GHz ISM applications with less than 1 dB loss. The design provides exceptional insertion loss performance, ideal for filter and receiver switching. RF1 and RF2 are reflective shorts when "Off". The two control voltages require a minimal amount of DC current and offer compatibility with most CMOS & TTL logic families. See HMC197 for same performance in an alternate SOT26 pin-out.

Electrical Specifications, $T_{A} = +25^{\circ}$ C, VctI = 0/+3 to +8 Vdc

Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz		0.4 0.45 0.6 0.8	0.7 0.8 0.9 1.1	dB dB dB dB
Isolation	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz	24 24 21 14	28 28 25 18		dB dB dB dB
Return Loss	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz	20 17 16 11	23 22 20 15		dB dB dB dB
Input Power for 1 dB Compression (VctI = 0/+5V)	0.5 - 1.0 GHz 0.5 - 3.0 GHz	25 23	30 29		dBm dBm
Input Third Order Intercept (VctI = 0/+5V) (Two-tone Input Power = +7 dBm Each Tone)	0.5 - 1.0 GHz 0.5 - 3.0 GHz	40 38	45 43		dBm dBm
Switching Characteristics	DC - 3.0 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)			3 10		ns ns

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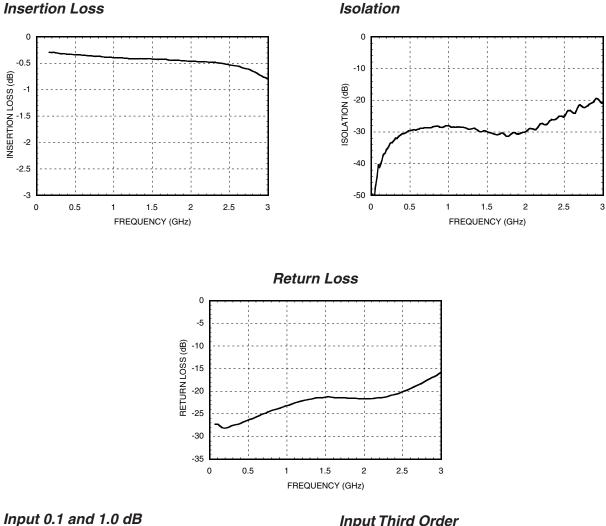
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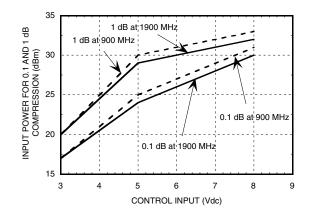
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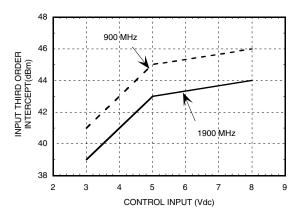
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Compression vs. Control Voltage



Input Third Order Intercept Point vs. Control Voltage



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Compression vs. Control Voltage

	Carrier at 900 MHz		Carrier at 1900 MHz		
Control Input	Input Power for 0.1 dB Compression	3 for 1.0 dB for 0.1 dB		Input Power for 1.0 dB Compression	
(Vdc)	(dBm)	(dBm)	(dBm)	(dBm)	
+3	17	20	17	20	
+5	25	30	24	29	
+8	31	33	30	32	

Caution: Do not operate in 1dB compression at power levels above +31 dBm (Vctl = +5 Vdc) and do not "hot switch" power levels greater than +20 dBm (Vctl = +5Vdc).

DC blocks are required at ports RFC, RF1 and RF2.

Distortion vs. Control Voltage

Control Input	Third Order Intercept (dBm) +7 dBm Each Tone		
(Vdc)	900 MHz	1900 MHz	
+3	41	39	
+5	45	43	
+8	46	44	

Truth Table

*Control Input Voltage Tolerances are \pm 0.2 Vdc.

Contro	ol Input*	Control Current		Signa	I Path
A (Vdc)	B (Vdc)	la (uA)	lb (uA)	RF to RF1	RF to RF2
0	+3	-10	10	ON	OFF
+3	0	10	-10	OFF	ON
0	+5	-55	55	ON	OFF
+5	0	55	-55	OFF	ON
0	+7	-210	210	ON	OFF
+7	0	210	-210	OFF	ON
0	+8	-280	280	ON	OFF
+8	0	280	-280	OFF	ON

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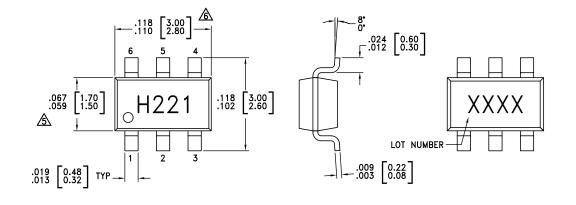


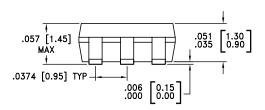
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Absolute Maximum Ratings

Control Voltage Range (A & B)	-0.2 to +12 Vdc
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Outline Drawing





NOTES:

- 1. PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEADFRAME MATERIAL: COPPER ALLOY
- 3. LEADFRAME PLATING: Sn/Pb SOLDER
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

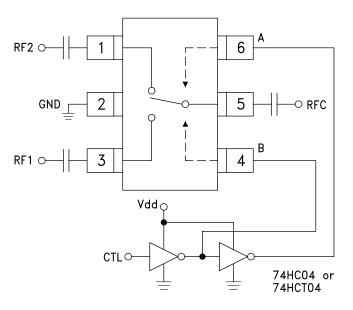
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GaAs MMIC SOT26 SPDT Switch , DC - 3 GHz

Typical Application Circuit



Notes:

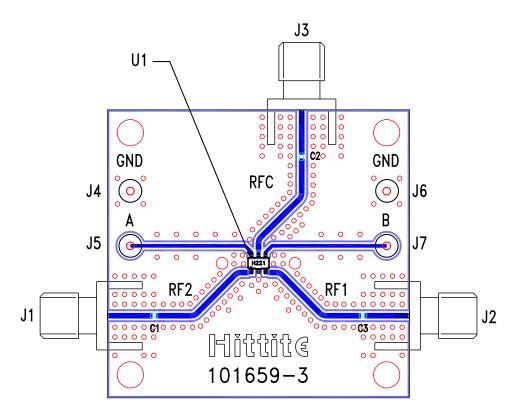
- 1. Set logic gate and switch Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
- 2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of 5 to 8 Volts applied to the CMOS logic gates.
- 3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
- 4. Highest RF signal power capability is achieved with Vdd = +8V and A/B set to 0/+8V.

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Evaluation Circuit Board



List of Material

Item	Description	
J1 - J3	PC Mount SMA RF Connector	
J4 - J7	DC Pin	
C1 - C3	330 pF capacitor, 0402 Pkg.	
U1 HMC221 SPDT Switch		
PCB* 101659 Evaluation PCB		
* Circuit Board Material: Rogers 4350		

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request. 14

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